



ABS AP163

Injection Molding Grade

Description

Permanent antistatic

Application

IC tray, electic/electronic products

Properties	Test Condition	Test Method	Unit	Typical Value
Physical				
Specific Gravity		ASTM D792	-	1.07
Molding Shrinkage (Flow), 3.2mm		ASTM D955	%	0.4~0.7
Melt Flow Rate	220℃/10kg	ASTM D1238	g/10min	30
Mechanical				
Tensile Strength, 3.2mm		ASTM D638		
@ Yield	50mm/min		kg/cm ²	440
Tensile Elongation, 3.2mm		ASTM D638	•	
@ Yield	50mm/min		%	>5
@ Break	50mm/min		%	>10
Tensile Modulus, 3.2mm	1mm/min	ASTM D638	kg/cm ²	16,900
Flexural Strength, 3.2mm	15mm/min	ASTM D790	kg/cm ²	710
Flexural Modulus, 3.2mm	15mm/min	ASTM D790	kg/cm ²	22,000
IZOD Impact Strength, 6.4mm		ASTM D256	•	
(Notched)	23 ℃		kg·cm/cm	
,	-30℃		kg·cm/cm	
IZOD Impact Strength, 3.2mm		ASTM D256		
(Notched)	23 ℃		kg·cm/cm	50
	-30℃		kg·cm/cm	
Rockwell Hardness	R-Scale	ASTM D785	-	98
Гhermal				
Heat Deflection Temperature, 6.4mm		ASTM D648		
(Unannealed)	18.6kg	A3 1 W D040	$^{\circ}$	87
(Onannealed)	4.6kg		C	90
Vicat Softening Temperature	4.0kg	ASTM D1525	C	90
vical Softening Temperature	5kg, 50℃/h	A3 1W D 1323	$^{\circ}$	94
Flammability	3kg, 30 C/II	UL94	U	5
i laminability		0L9 4	class	НВ
Relative Temperature Index		UL 746B	Class	TID
Electrical		OL 740D	$^{\circ}$ C	60
Mechanical with Impact			°C	60
Mechanical without Impact			C	60
Wednamear without impact			<u> </u>	
Electrical				
Comparative Tracking Index(CTI)	Solution A	IEC 60112	Volts	0
Surface Resistivity	23℃	ASTM D257	Ohm	1.0E+12
Volume Resistivity	23 ℃	ASTM D257	Ohm∙m	
Arc Resistance	23℃	ASTM D495	Ohm·cm	5

Note) Typical values are only for material selection purpose, and variation within normal tolerances are for various colors.

Values given should not be interpreted as specification and not be used for part or tool design.

All properties, except melt flow rate are measured on injection molulded specimens and after 48 hours storage at 23 °C, 50% relative humidty.

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Processing Guide (Injection Molding)

Processing Parameters		Unit	Value
Drying Temperature		${\mathbb C}$	80
Drying Time		hrs	2 ~ 4
Minimum Moisture Content		%	0.01
Melt Temperature		${\mathbb C}$	210 ~ 240
Cylinder Temperature	Rear	${\mathbb C}$	180 ~ 200
	Middle	${\mathbb C}$	190 ~ 210
	Front	${\mathbb C}$	200 ~ 220
Nozzle Temperature		${\mathbb C}$	200 ~ 230
Mold Temperature		${\mathbb C}$	40 ~ 70
Back Pressure		kg/cm ²	300 ~ 600
Screw Speed		rpm	30 ~ 60

Note) Back Pressure & Screw Speed are only mentioned as general guidelines.

These may not apply or need adjustment in specific situations such as low shot sizes, thin wall molding and gas-assist molding.